XPand1200

End of Life

3U VPX Development Platform for Up to Eight Conduction-Cooled Modules

Please contact X-ES Sales

- Development platform for conduction-cooled modules
- Forced-air-cooled sidewall heat exchangers
- Supports eight 0.8 in. or 1.0 in. pitch conductioncooled VPX modules
- Standard VPX configurations available
- ➤ Compatible with multiple VITA 65 OpenVPX[™] slot profiles
- Customizable with X-ES and third-party components
- Rear Transition Module (RTM) support for maximum I/O flexibility
- Front panel power and reset switches
- Front panel power and reset LEDs
- Up to 550 W of total simultaneous power
- Up to 60 W per slot at 30°C ambient and 70°C rail
- Two VITA 62 power slots
- > 12 V up to 50 A
- > 5 V up to 50 A
- > 3.3 V up to 80 A
- ±12 V_AUX and 3.3 V_AUX
- 110-240 VAC, 50/60 Hz power input



"Fast, Flexible, Customer-Focused Embedded Solutions" **Extreme Engineering Solutions**

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The XPand1200 is a low-cost, flexible development platform, supporting up to eight 0.8 in. or 1.0 in. pitch conduction-cooled VPX (VITA 48.2) modules. It provides 550 W of total simultaneous power, which can be distributed as up to 50 A on 12 V, up to 50 A on 5 V, and up to 80 A on 3.3 V. The heat from the internal conduction-cooled modules is conducted to sidewall exchangers, where it is dissipated to the ambient environment by forced-air cooling. This efficient thermal design allows up to 60 W of power dissipation per slot at 30°C ambient, while maintaining 70°C at the module's thermal interface.

X-ES platforms like the XPand1200 provide a feature-rich solution for system development. Rear Transition Modules (RTMs) provide maximum I/O flexibility and rapid system prototyping. Power and reset LEDs are provided for system status. A momentary push-button is provided for reset, and a switch is provided for DC power enable.

The XPand1200 is currently available for purchase in several rapid-development standard configurations. Custom configurations of modules, RTMs, and backplanes are also available utilizing X-ES and third-party components.

Form Factor

- 3U VPX (VITA 48.2) 0.8 in. or 1.0 in. pitch
- 3U VPX (VITA 46.10) RTM

Slots

- Eight 0.8 in. or 1.0 in. pitch RTM slots
- Eight 0.8 in. or 1.0 in. pitch payload slots
- Two 0.8 in. or 1.0 in. pitch power slots

Power

- 110-240 VAC, 50/60 Hz power input
- 550 W total simultaneous power
- Up to 50 A on 12 V
- Up to 50 A on 5 V
 Up to 80 A on 3.3 V
- Up to 8 A on ±12 V_AUX
- Up to 8 A on 3.3 V_AUX

- Cooling
- Up to 60 W per slot at 30°C ambient and 70°C rail

Physical Characteristics

- Dimensions: 11.5 in. (L) x 5.5 in. (W) x 16.5 in. (H)
- 20 lbs. with backplane and power supply



